

Design Example Report

Title	<i>12 W Non-Isolated, Buck-Boost Topology, Power Factor Corrected, LED Driver Using LinkSwitch™-PH LNK406EG</i>
Specification	90 VAC – 265 VAC Input; 36 V, 330 mA Output
Application	LED Driver
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Summary and Features

- Dramatically simplifies off-line, power factor corrected, LED driver design
 - Single-stage, power factor corrected, non-isolated LED driver
 - Compact with extremely low component count
 - High PF >0.9 across line and load
 - High efficiency >85%
 - Low THD, <25% at 230 VAC
 - Eliminates all control loop compensation
 - No output current sensing required
- Advanced performance features
 - Compensates for inductance tolerance
 - Compensates for input voltage variations
 - Compensates for output voltage variations
 - Frequency jittering greatly reduces EMI filter costs
- Advanced protection and safety features
 - Auto-restart protection for short-circuit
 - Hysteretic thermal shutdown

PATENT INFORMATION

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Important Note:



Although this board is designed to satisfy safety isolation requirements, the engineering prototype has not been agency approved. Therefore, all testing should be performed using an isolation transformer to provide the AC input to the prototype board.



1 Introduction

The document describes a non-isolated, power factor corrected, low THD, high-efficiency LED driver designed to drive 36 V at 330 mA from an input voltage range of 90 VAC to 265 VAC.

The LinkSwitch-PH has been developed to cost effectively design a single-stage power factor corrected LED driver with primary-side constant current control. The LinkSwitch-PH controller was optimized for LED driver applications with minimal external parts count and control of the output current through the LED load without the use of an optocoupler.

The LinkSwitch-PH monolithically integrates the 725 V power MOSFET and controller. The controller consists of an oscillator, PWM, 6 V regulator, BYPASS (BP) pin programming functions, over-temperature protection, frequency jittering, cycle-by-cycle current limit, leading edge blanking, and charge controller for output CC (constant current) control.

The LinkSwitch-PH also provides a sophisticated range of protection features including auto-restart for control loop open/short faults and output short-circuit conditions. Accurate hysteretic thermal shutdown ensures safe average PCB temperatures under all conditions.

The non-isolated power factor corrected buck-boost presented in this report shows how LinkSwitch-PH dramatically simplifies off-line, high-efficiency, power factor corrected LED driver design with very low parts count.

This document contains the LED driver specification, schematic, PCB diagram, bill of materials, conducted EMI measurements, thermal measurements, inductor documentation and typical performance characteristics.

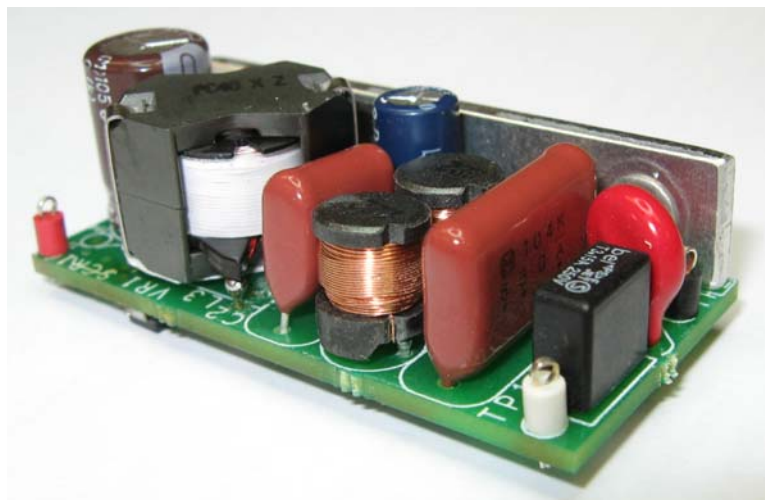
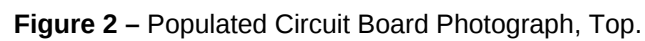


Figure 1 – Populated Circuit Board Photograph.



2 Power Supply Specification

The table below represents the minimum acceptable performance of the design. Actual performance is listed in the results section.

Description	Symbol	Min	Typ	Max	Units	Comment
Input						
Voltage	V_{IN}	90		265	VAC	2 Wire – no P.E.
Frequency	f_{LINE}	47	50/60	63	Hz	
Output						
LED voltage	V_{OUT}	30	36	38	V	
LED Current			330		mA	
Total Output Power						
Continuous Output Power	P_{OUT}		12		W	
Environmental						
Conducted EMI		Meets CISPR22B / EN55022B				
Safety		Non-isolated				
Efficiency		83				
Harmonic		Class C				61000-3-2
Power Factor		0.9				
Ambient Temperature	T_{AMB}		25		°C	



3 Schematic

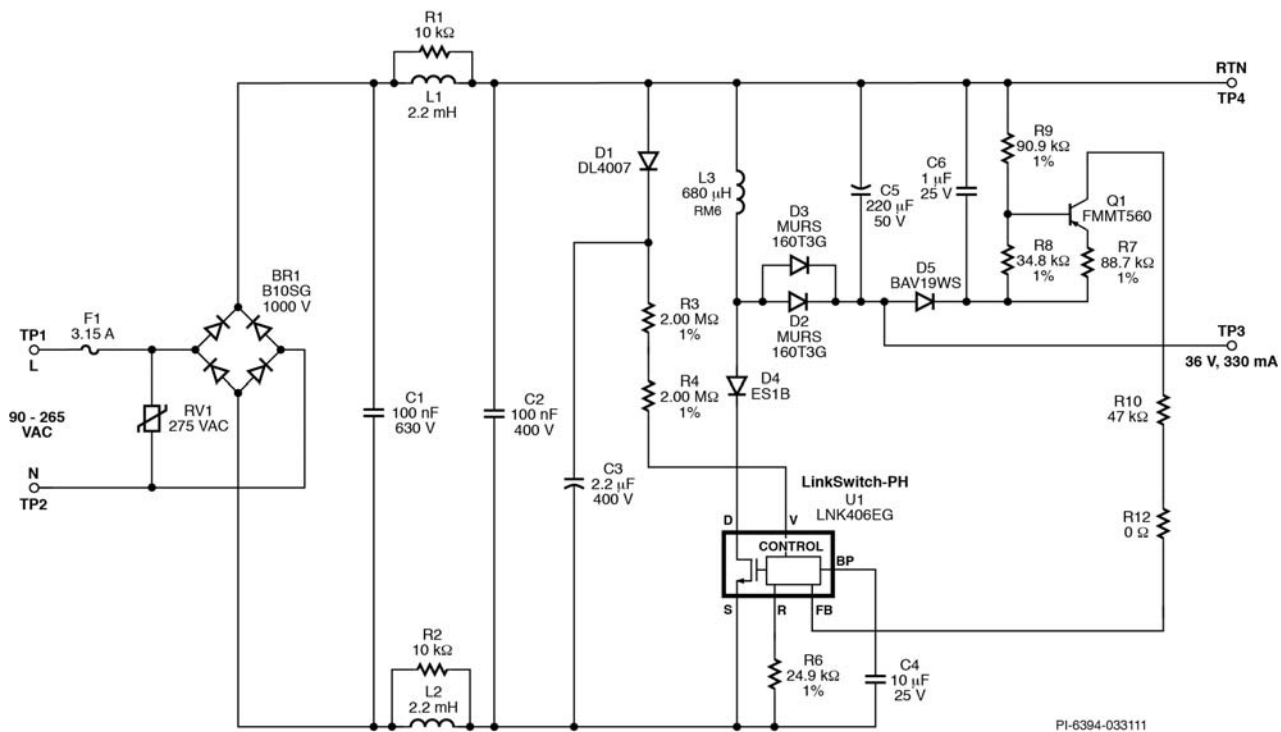


Figure 4 – Schematic.



4 Circuit Description

The LinkSwitch-PH (U1) is a highly integrated primary-side controller intended for use in LED driver applications. The LinkSwitch-PH provides high power factor in a single-stage conversion topology while regulating the output current in a wide range of input and output voltage variations typical in LED driver application environment. All of the control circuitry responsible for these functions plus a high-voltage power MOSFET is incorporated into the device.

Capacitor C1, C2, and differential choke L1, and L2 perform EMI filtering while maintaining high-power factor. This input filter network plus the frequency jittering feature of LinkSwitch-PH easily meets Class B emission limits. Resistor R1 and R2 were used to damp the Q of L1 and L2 for lower EMI.

The buck-boost power circuit with floating output connection composed of U1 (power switch + control), D2 and D3 (free-wheeling diode), C5 (output capacitor), and L3 (output inductor). Diode D4 was used to prevent negative voltage appearing across drain-source of U1 near the zero-crossing of the input voltage. Diode D1 and C3 detect the peak AC line voltage. The voltage across C3 along with R3, R4, and R5 sets input current fed into the VOLTAGE MONITOR (V) pin. This current is used by U1 to control line undervoltage (UV), overvoltage (OV), and feed-forward current which in conjunction with the FEEDBACK (FB) pin current provides constant current to the LED load.

The FB pin current used by U1 for output voltage feedback is provided by the voltage to current converter network formed by R7-R10, Q1, C6, and D4. Output voltage is converted to feedback current by the following relation:

$$I_{FB} \approx k \times V_{OUT}$$

where

$$k = \frac{1}{R7} \times \frac{R8}{R8 + R9}$$

Voltage across R8 was chosen high enough to eliminate or minimize the effect of the temperature and V_{CE} dependence of Q1's V_{BE} voltage.



5 PCB Layout

The RD-257 assembled board was used.

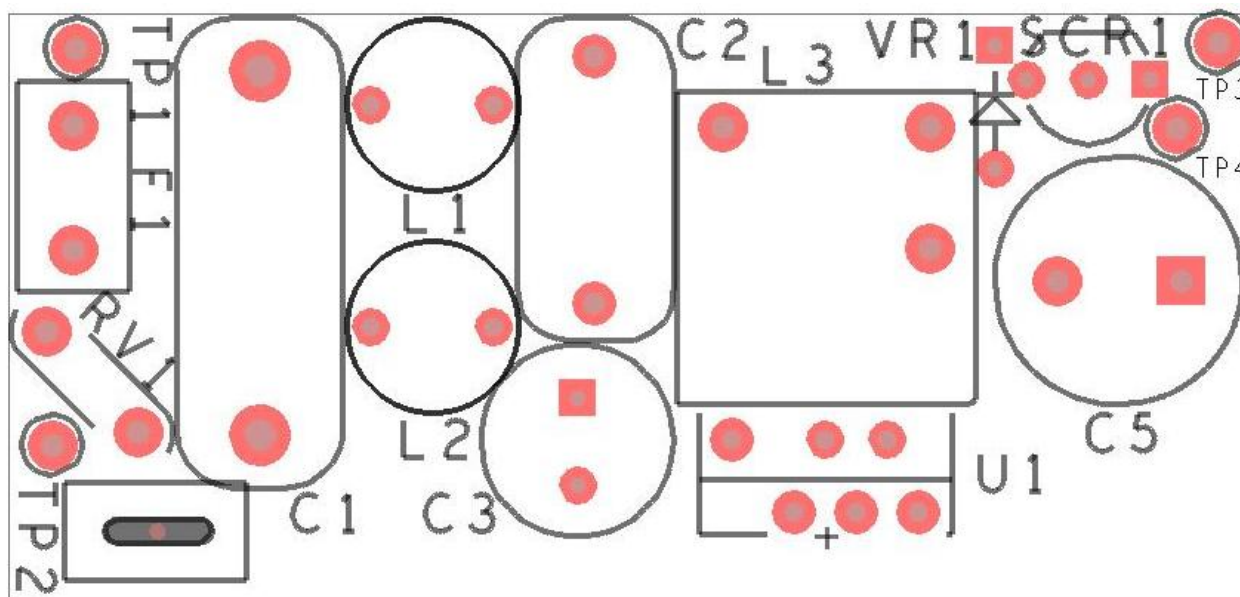


Figure 2 – Printed Circuit Layout, Top, 2" (50.8 mm) x 0.95" (24.1 mm).

The modifications to the RD-257 PCB are shown below. Inductor L3 was removed and reworked into the location on the PCB for D2. Diodes D2 and D3 were removed and soldered into locations indicated.

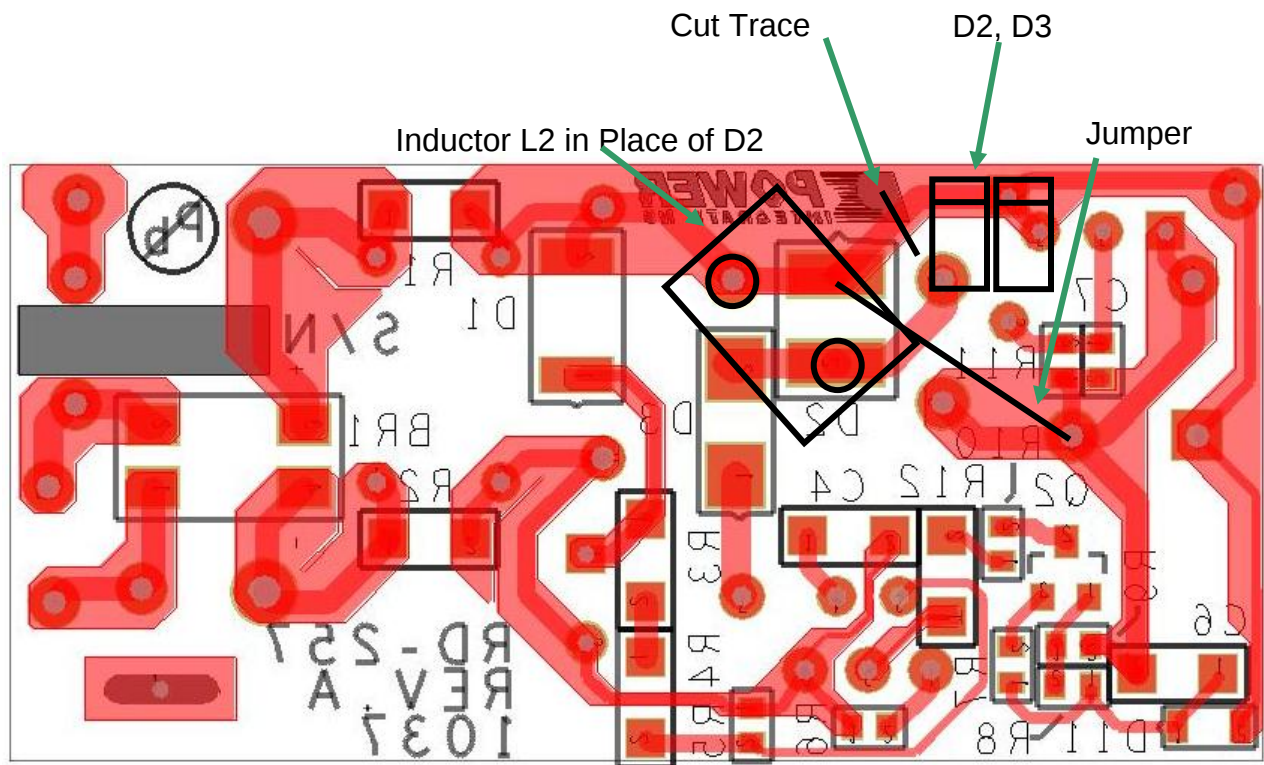


Figure 3 – Printed Circuit Layout, Bottom.

6 Bill of Materials

6.1 Electrical

Item	Qty	Ref Des	Description	Mfg Part Number	Mfg
1	1	BR1	1000 V, 0.8 A, Bridge Rectifier, SMD, MBS-1, 4-SOIC	B10S-G	Comchip
2	1	C1	100 nF, 630 V, Film	ECQ-E6104KF	Panasonic
3	1	C2	100 nF, 400 V, Film	ECQ-E4104KF	Panasonic
4	1	C3	2.2 μ F, 400 V, Electrolytic, (8 x 11.5)	SMG400VB2R2M8X11LL	Nippon Chemi-Con
5	1	C4	10 μ F, 25 V, Ceramic, X7R, 1206	ECJ-3YB1E106M	Panasonic
6	1	C5	220 μ F, 50 V, Electrolytic, Very Low ESR, 42 m Ω , (10 x 16)	EKZE500ELL221MJ16S	Nippon Chemi-Con
7	1	C6	1 μ F, 25 V, Ceramic, X7R, 1206	HMK316B7105KL-T	Taiyo Yuden
8	1	D1	1000 V, 1 A, Rectifier, Glass Passivated, DO-213AA (MELF)	DL4007-13-F	Diodes Inc
9	2	D2 D3	600 V, 1 A, Ultrafast Recovery, 35 ns, SMB Case	MURS160T3G	On Semi
10	1	D4	100 V, 1 A, Ultrafast Recovery, 25 ns, DO-214AC	ES1B-13-F	Diodes Inc
11	1	D5	100 V, 0.2 A, Fast Switching, 50 ns, SOD-323	BAV19WS-7-F	Diodes Inc
12	1	F1	3.15 A, 250 V, Slow, RST	507-1181	Belfuse
13	2	L1 L2	2.2 mH, 0.19 A, Ferrite Core	CTCH895F-222K	CT Parts
14	1	L3	0.68 mH, RM6 Ferrite Core		
15	1	Q1	PNP, Small Signal BJT, 500 V, 0.15 A, SOT23	FMMT560TA	Zetex
16	2	R1 R2	10 k Ω , 5%, 1/4 W, Thick Film, 1206	ERJ-8GEYJ103V	Panasonic
17	2	R3 R4	2.00 M Ω , 1%, 1/4 W, Thick Film, 1206	ERJ-8ENF2004V	Panasonic
18	1	R6	24.9 k Ω , 1%, 1/16 W, Thick Film, 0603	ERJ-3EKF2492V	Panasonic
19	1	R7	88.7 k Ω , 1%, 1/16 W, Thick Film, 0603	ERJ-3EKF8872V	Panasonic
20	1	R8	34.8 k Ω , 1%, 1/16 W, Thick Film, 0603	ERJ-3EKF3482V	Panasonic
21	1	R9	90.9 k Ω , 1%, 1/16 W, Thick Film, 0603	ERJ-3EKF9092V	Panasonic
22	1	R10	47 k Ω , 5%, 1/10 W, Thick Film, 0603	ERJ-3GEYJ473V	Panasonic
23	1	R12	0 Ω , 5%, 1/4 W, Thick Film, 1206	ERJ-8GEY0R00V	Panasonic
24	1	RV1	275 V, 23 J, 7 mm, RADIAL	V275LA4P	Littlefuse
25	1	U1	LinkSwitch-PH, eSIP	LNK406EG	Power Integrations

6.2 Mechanical

Item	Qty	Ref Des	Description	Part Number	Mfg
1	1	HSK	RD257_HSK		
2	1	SCREW1	SCREW MACHINE PHIL Flat head 4-40 X 1/4 SS		
3	1	ESIP CLIP1	Heat sink Hardware, Edge Clip 16.5 mm L x 7.5 mm W x 0.5 mm H	PH-3	
4	1	NUT1	Nut, Hex 4-40, SS		
5	1	TE1	Terminal, Eyelet, Tin Plated Brass, Zierick PN 190	190	Zierick
6	1	TP1	Test Point, WHT, Miniature THRU-HOLE MOUNT	5002	Keystone
7	2	TP2 TP4	Test Point, BLK, Miniature THRU-HOLE MOUNT	5001	Keystone
8	1	TP3	Test Point, RED, Miniature THRU-HOLE MOUNT	5000	Keystone



7 Heat Sink Assembly

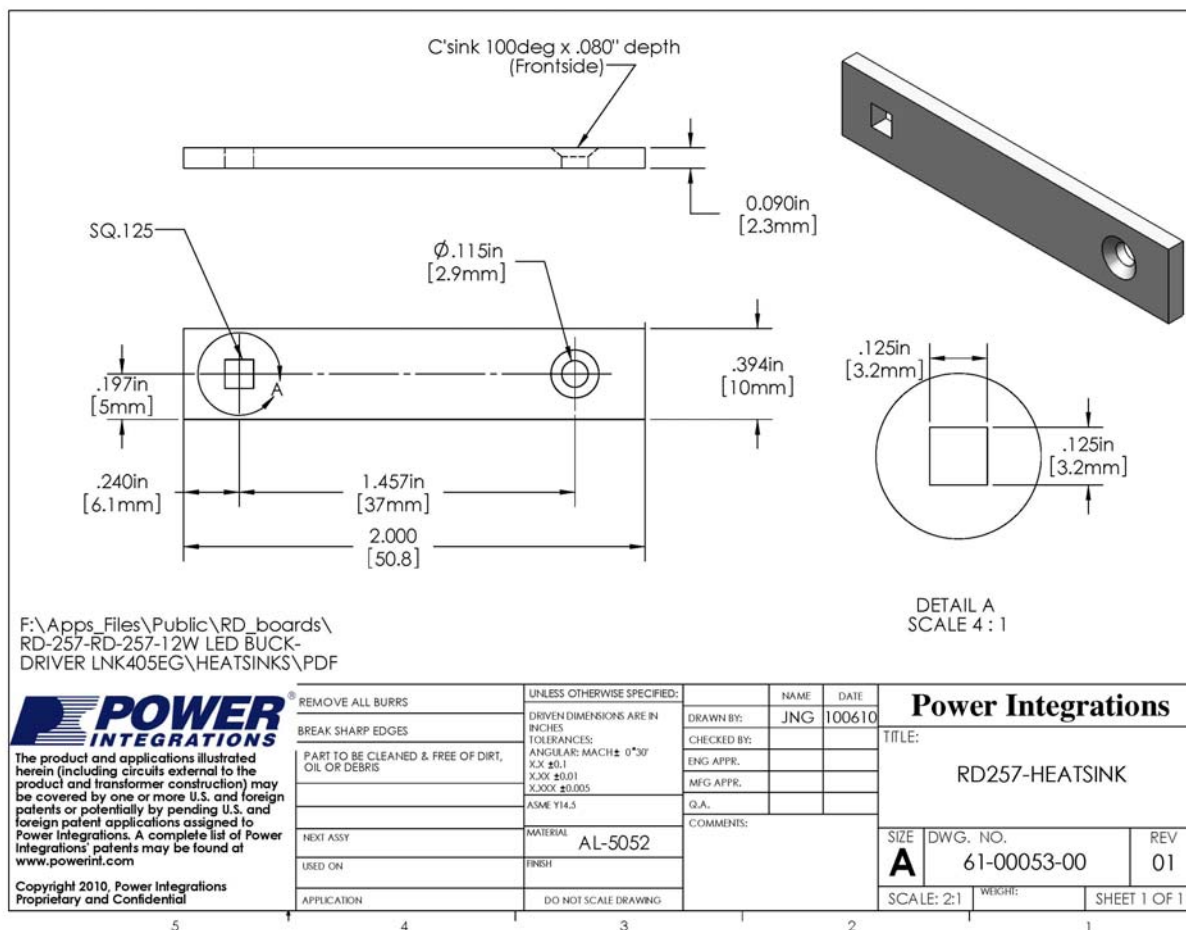


Figure 4 – Heat Sink Dimensions.

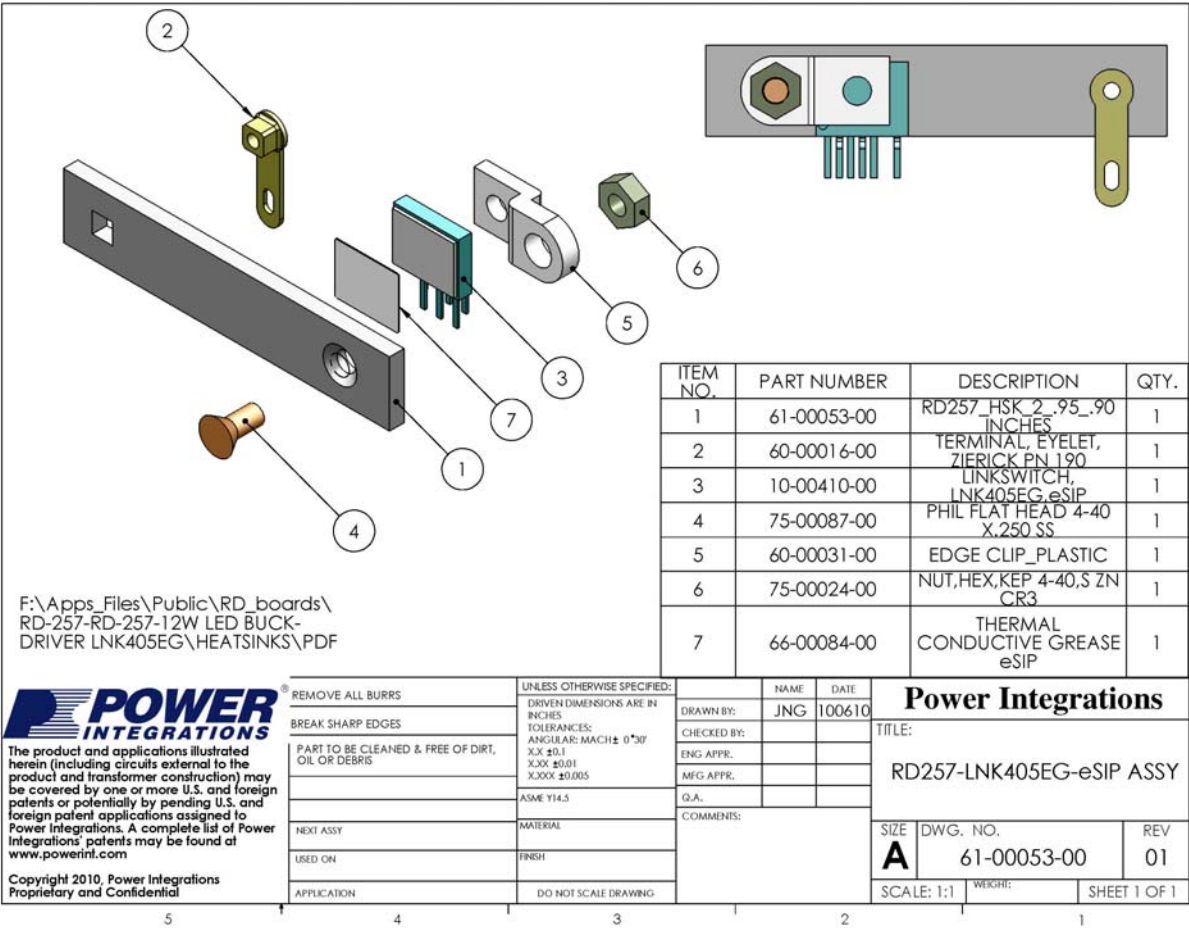


Figure 5 – Heat Sink Assembly Drawing.

8 Inductor Specification

8.1 Electrical Diagram

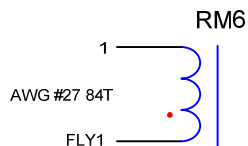


Figure 6 – Inductor Electrical Diagram.

8.2 Electrical Specifications

Inductance	Pins 1-FLY1, all other windings open, measured at 66 kHz, 0.4 V _{RMS}	680 μ H $\pm$ 5%
Resonant Frequency	Pins 1-FLY1, all other windings open	1 MHz (Min.)

8.3 Materials

Item	Description
[1]	Core: PC44 RM6 (NC2H).
[2]	Bobbin: RM6, Vertical, 6 pins, 3/3.
[3]	Magnet Wire: #27 AWG.
[4]	Tape: 3M 1298 Polyester Film, 6.4 mm wide.

8.4 Inductor Build Diagram

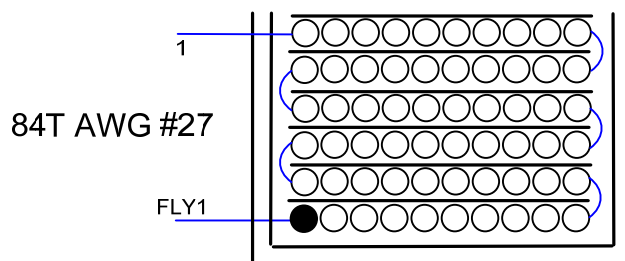


Figure 7 – Inductor Build Diagram.

9 Performance Data

The following data were measured using 3 sets of load (i.e. 11, 12, and 13 LED strings to represent the load range of 30 V ~ 36 V output voltage / 10 W ~ 12 W output power). Refer to the table on Section 9.6 for the complete set of test data values. All measurements performed at room temperature.

9.1 Efficiency

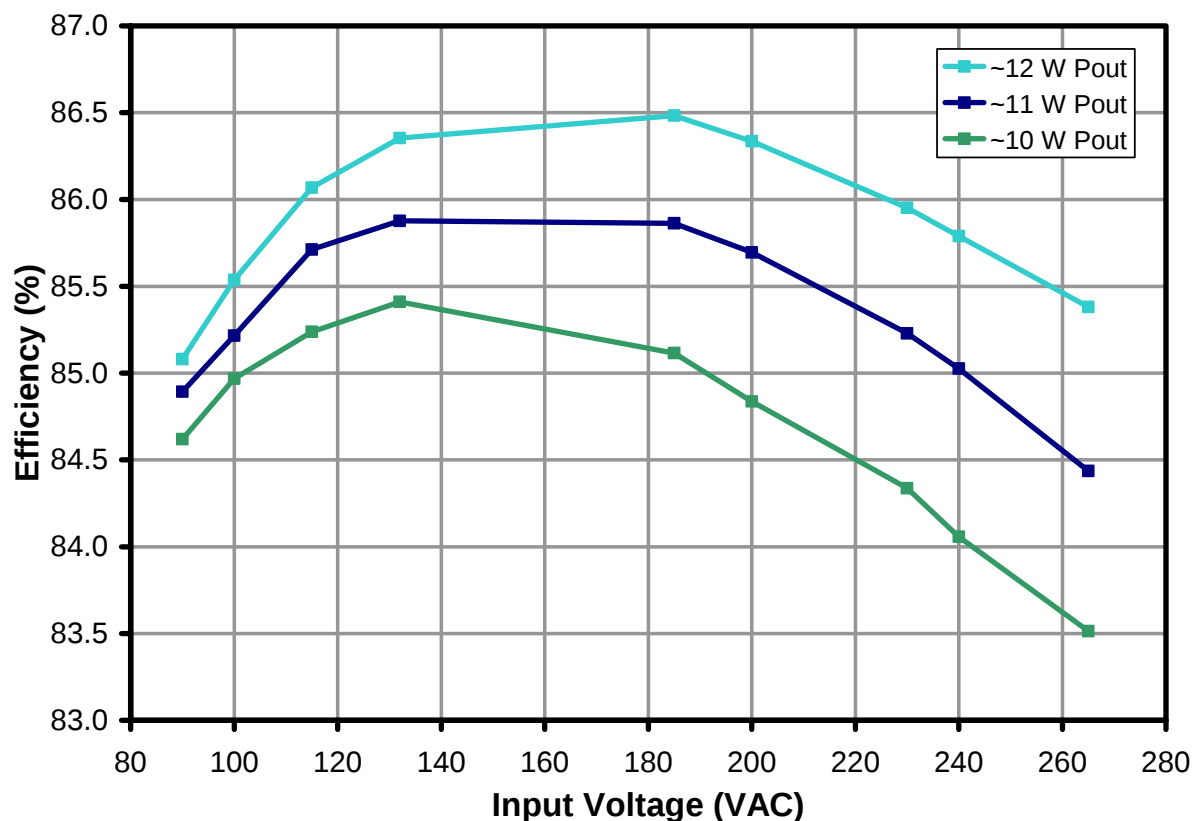


Figure 8 – Efficiency vs. Load and Input Voltage.



9.2 Line and Load Regulation

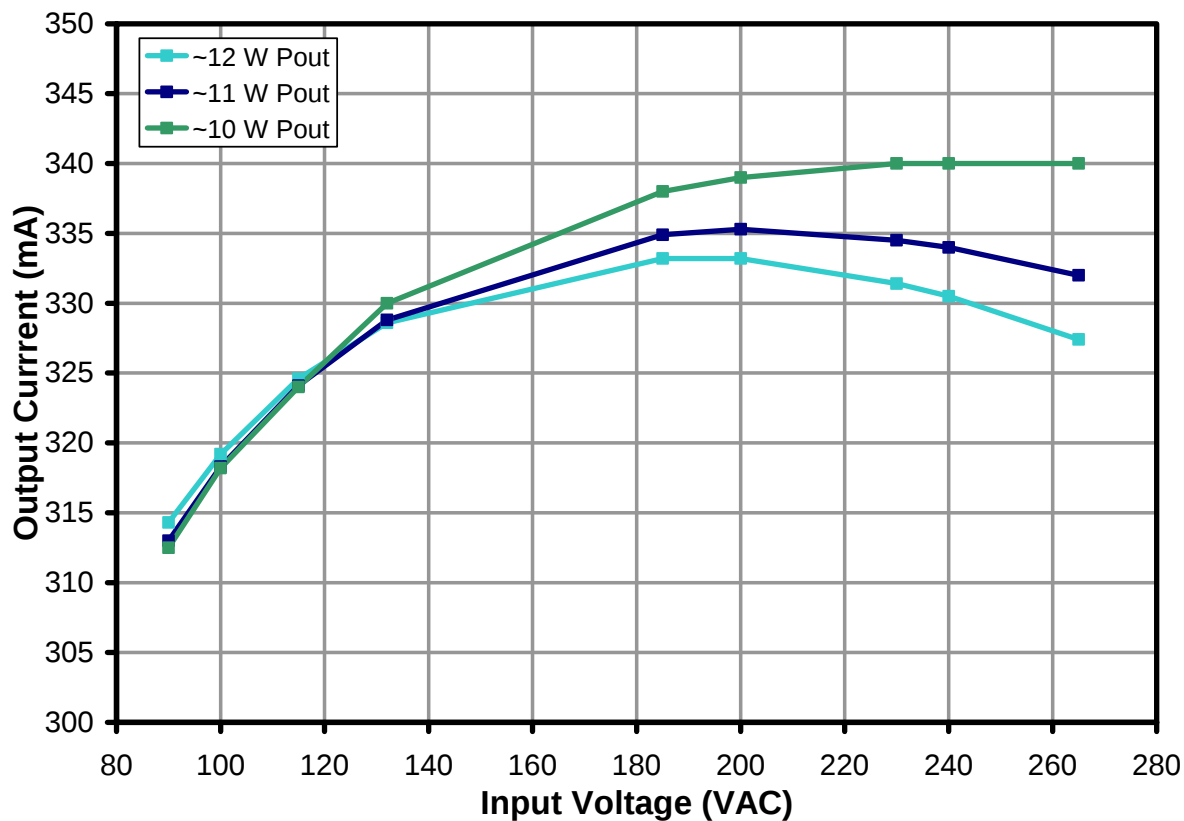


Figure 9 – Regulation vs. Load and Input Voltage.

9.3 Power Factor

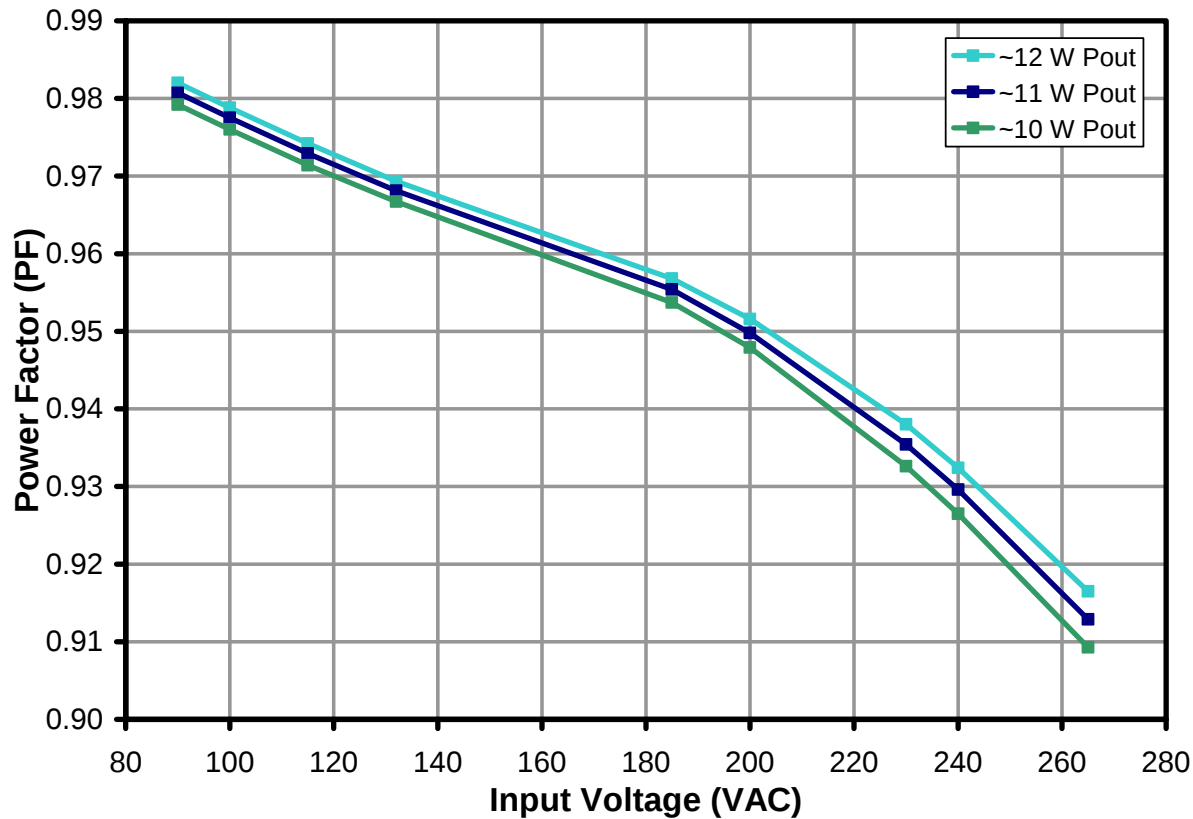


Figure 10 – Power Factor vs. Load and Input Voltage.



9.4 THD

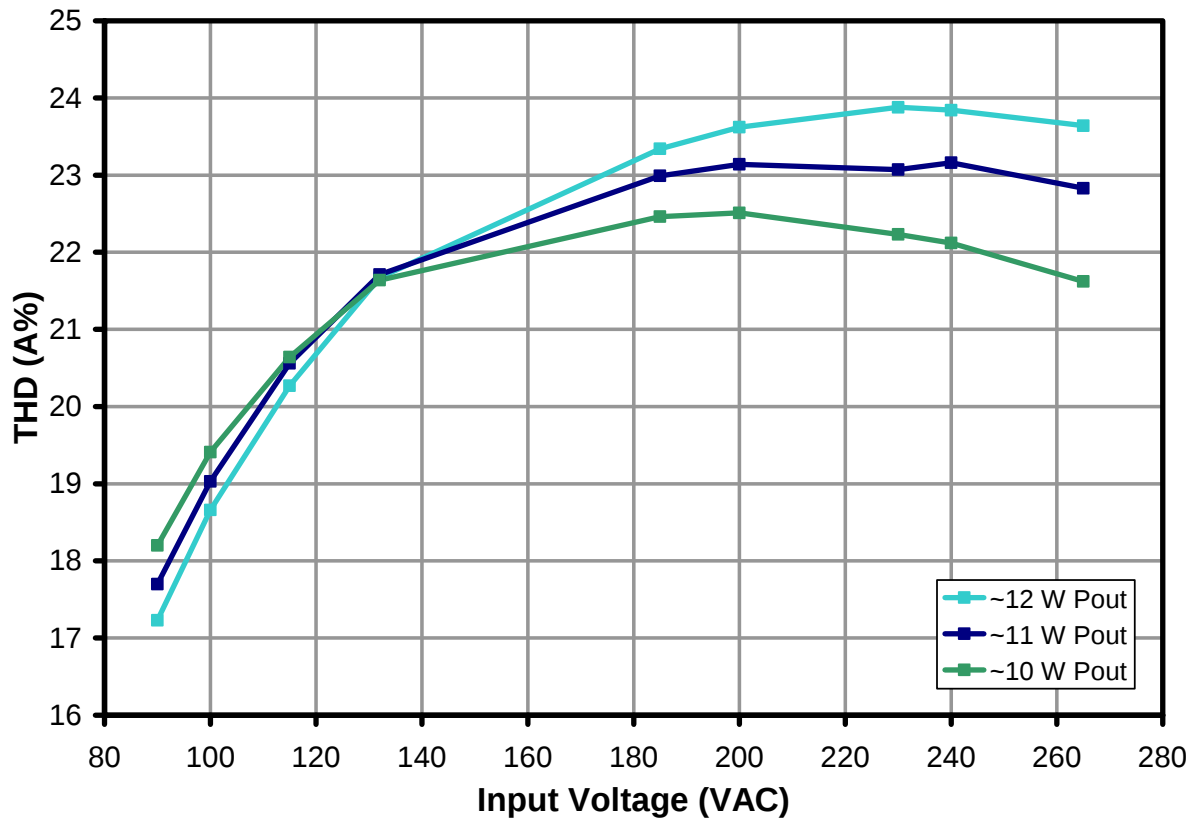


Figure 11 – THD vs. Load and Input Voltage.

9.5 Harmonics

9.5.1 230 VAC

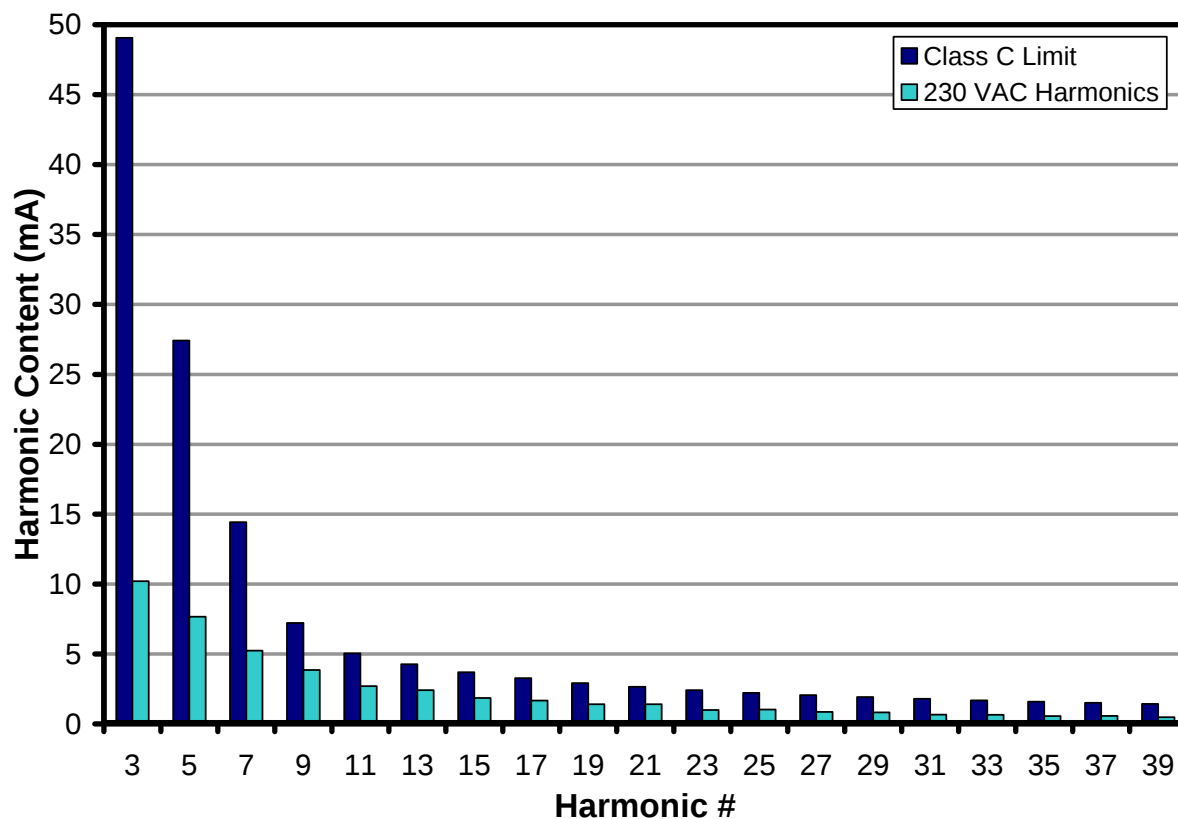


Figure 12 – 230 VAC Input Current Harmonics.



9.5.2 115 VAC

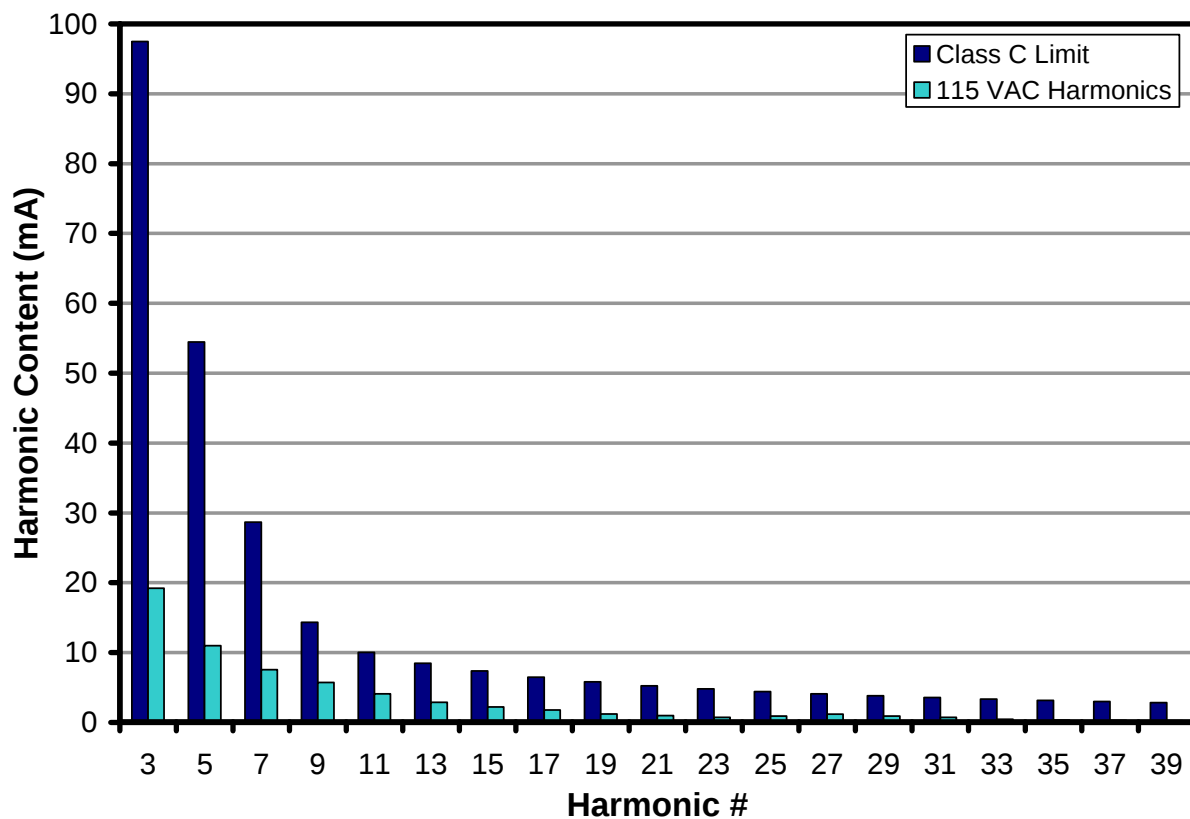


Figure 13 – 115 VAC Input Current Harmonics.

9.6 Test Data

All measurements were taken with the board at open frame, 25 °C ambient.

9.6.1 Test Data, 13 LED Load

Input		Input Measurement				Load Measurement			
VAC (V _{RMS})	Freq (Hz)	I (mA _{RMS})	P (W)	PF	%ATHD	V (V _{DC})	I (mA _{DC})	P _O (W)	Efficiency (%)
90	60	157.56	13.93	0.982	17.23	37.41	314.30	11.85	85.08
100	60	142.99	13.99	0.979	18.66	37.19	319.20	11.97	85.54
115	60	125.86	14.11	0.974	20.27	37.09	324.60	12.14	86.07
132	60	111.01	14.21	0.969	21.67	37.04	328.60	12.27	86.35
185	50	81.31	14.40	0.957	23.34	36.99	333.20	12.45	86.48
200	50	75.68	14.41	0.952	23.62	36.96	333.20	12.44	86.33
230	50	66.62	14.38	0.938	23.88	36.94	331.40	12.36	85.95
240	50	64.14	14.36	0.932	23.84	36.93	330.50	12.32	85.79
265	50	58.81	14.29	0.917	23.64	36.92	327.40	12.20	85.38
						MAX	333.20	0.97%	
						MIN	314.30	4.76%	

9.6.2 Test Data, 12 LED Load

Input		Input Measurement				Load Measurement			
VAC (V _{RMS})	Freq (Hz)	I (mA _{RMS})	P (W)	PF	%ATHD	V (V _{DC})	I (mA _{DC})	P _O (W)	Efficiency (%)
90	60	145.84	12.88	0.981	17.70	34.62	313.00	10.93	84.89
100	60	132.66	12.97	0.978	19.03	34.41	318.30	11.05	85.22
115	60	117.06	13.10	0.973	20.56	34.33	324.10	11.23	85.71
132	60	103.57	13.24	0.968	21.71	34.29	328.80	11.37	85.88
185	50	76.42	13.51	0.955	22.99	34.26	334.90	11.60	85.86
200	50	71.29	13.55	0.950	23.14	34.24	335.30	11.61	85.70
230	50	63.12	13.59	0.935	23.07	34.24	334.50	11.58	85.23
240	50	60.91	13.60	0.930	23.16	34.23	334.00	11.56	85.03
265	50	56.17	13.60	0.913	22.83	34.22	332.00	11.48	84.44
						MAX	335.30	1.61%	
						MIN	313.00	5.15%	



9.6.2 Test Data, 11 LED Load

Input		Input Measurement				Load Measurement			Efficiency (%)
VAC (V _{RMS})	Freq (Hz)	I (mA _{RMS})	P (W)	PF	%ATHD	V (V _{DC})	I (mA _{DC})	P _O (W)	
90	60	134.59	11.87	0.979	18.20	31.83	312.50	10.04	84.62
100	60	122.76	11.98	0.976	19.41	31.66	318.20	10.18	84.97
115	60	108.88	12.17	0.971	20.64	31.57	324.00	10.37	85.24
132	60	96.49	12.32	0.967	21.64	31.55	330.00	10.52	85.41
185	50	71.84	12.68	0.954	22.46	31.53	338.00	10.79	85.11
200	50	67.25	12.75	0.948	22.51	31.51	339.00	10.82	84.84
230	50	59.94	12.87	0.933	22.23	31.50	340.00	10.85	84.34
240	50	57.97	12.90	0.927	22.12	31.49	340.00	10.84	84.06
265	50	53.79	12.97	0.909	21.62	31.48	340.00	10.83	83.51
						MAX	340.00	3.03%	
						MIN	312.50	5.30%	



9.6.3 230 VAC Harmonics Data

Freq	V	I (mA)	P	PF	%THD
49.998	230.11	66.86	14.4300	0.9381	23.93
	nth Order	mA content	Base Limit mA/W	Actual Limit	Remarks
	1	64.06			
	3	10.20	3.40000	49.0620	Pass
	5	7.66	1.90000	27.4170	Pass
	7	5.23	1.00000	14.4300	Pass
	9	3.85	0.50000	7.2150	Pass
	11	2.69	0.35000	5.0505	Pass
	13	2.41	0.29615	4.2735	Pass
	15	1.85	0.25667	3.7037	Pass
	17	1.66	0.22647	3.2680	Pass
	19	1.42	0.20263	2.9240	Pass
	21	1.42	0.18333	2.6455	Pass
	23	1.00	0.16739	2.4155	Pass
	25	1.03	0.15400	2.2222	Pass
	27	0.85	0.14259	2.0576	Pass
	29	0.83	0.13276	1.9157	Pass
	31	0.67	0.12419	1.7921	Pass
	33	0.65	0.11667	1.6835	Pass
	35	0.56	0.11000	1.5873	Pass
	37	0.57	0.10405	1.5015	Pass
	39	0.47	0.09872	1.4245	Pass
	41	0.48			
	43	0.38			
	45	0.38			
	47	0.38			
	49	0.48			



9.6.3 115 VAC Harmonics Data

Freq	V	I (mA)	P	PF	%THD
59.998	115.02	127.89	14.3350	0.9745	20.31
	nth Order	mA Content	Base Limit mA/W	Actual Limit	Remarks
	1	124.19			
	3	19.23	3.40000	97.4780	Pass
	5	11.00	1.90000	54.4730	Pass
	7	7.56	1.00000	28.6700	Pass
	9	5.72	0.50000	14.3350	Pass
	11	4.09	0.35000	10.0345	Pass
	13	2.88	0.29615	8.4907	Pass
	15	2.22	0.25667	7.3586	Pass
	17	1.79	0.22647	6.4929	Pass
	19	1.22	0.20263	5.8094	Pass
	21	0.99	0.18333	5.2562	Pass
	23	0.74	0.16739	4.7991	Pass
	25	0.92	0.15400	4.4152	Pass
	27	1.18	0.14259	4.0881	Pass
	29	0.93	0.13276	3.8062	Pass
	31	0.72	0.12419	3.5606	Pass
	33	0.45	0.11667	3.3448	Pass
	35	0.35	0.11000	3.1537	Pass
	37	0.30	0.10405	2.9832	Pass
	39	0.24	0.09872	2.8302	Pass
	41	0.16			
	43	0.13			
	45	0.10			
	47	0.09			
	49	0.10			



10 Waveforms

10.1 Input Line Current

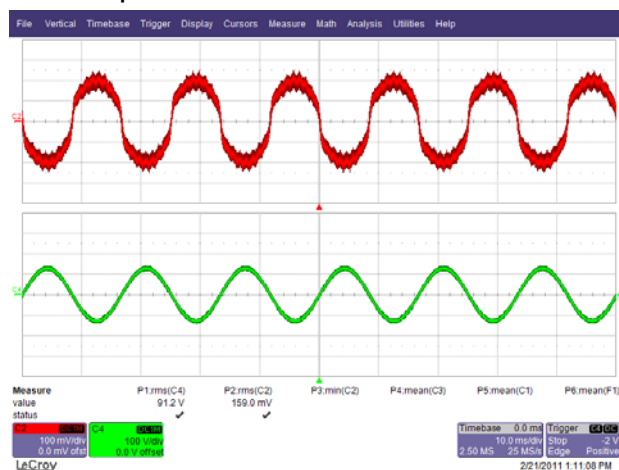


Figure 14 – 90 VAC 60 Hz, Full Load.
Upper: I_{IN} , 100 mA / div.
Lower: V_{IN} , 100 V, 10 ms / div.

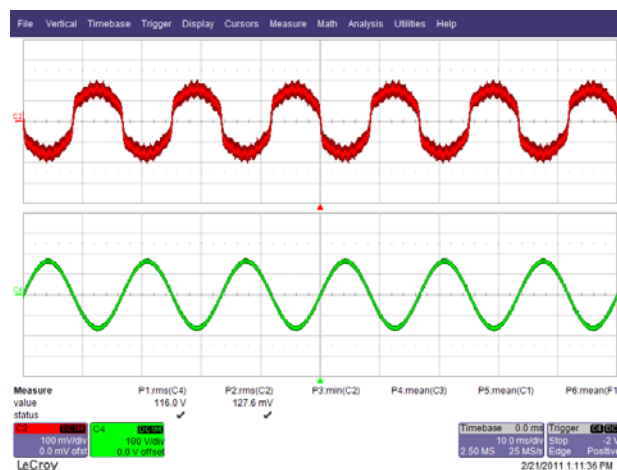


Figure 15 – 115 VAC 60 Hz, Full Load.
Upper: I_{IN} , 100 mA / div.
Lower: V_{IN} , 100 V, 10 ms / div.

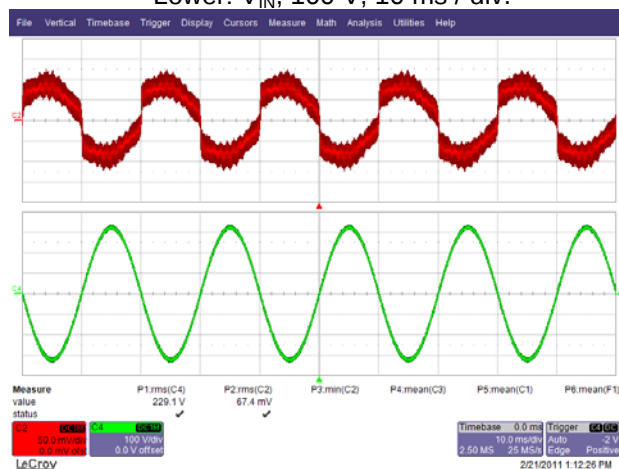


Figure 16 – 230 VAC 50 Hz, Full Load.
Upper: I_{IN} , 50 mA / div.
Lower: V_{IN} , 100 V, 10 ms / div.

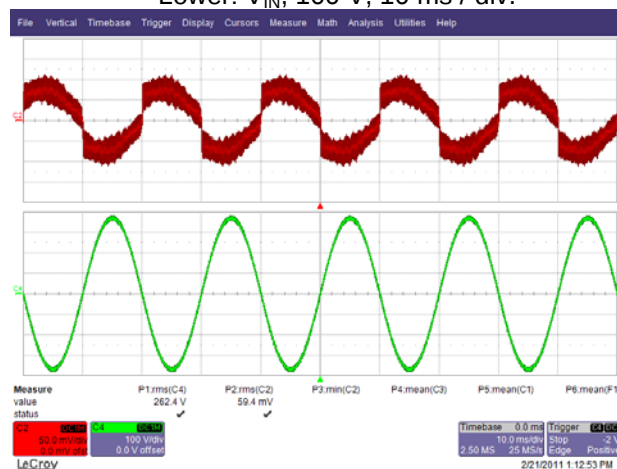


Figure 17 – 265 VAC 50 Hz, Full Load.
Upper: I_{IN} , 50 mA / div.
Lower: V_{IN} , 100 V, 10 ms / div.

10.2 Drain Voltage and Current Normal Operation

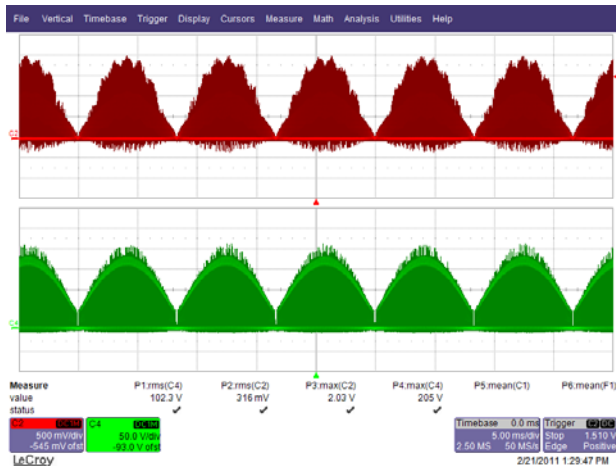


Figure 18 – 90 VAC 60Hz, Full Load.
Upper: I_{DRAIN} , 500 mA / div.
Lower: V_{DRAIN} , 50 V, 5 ms / div.

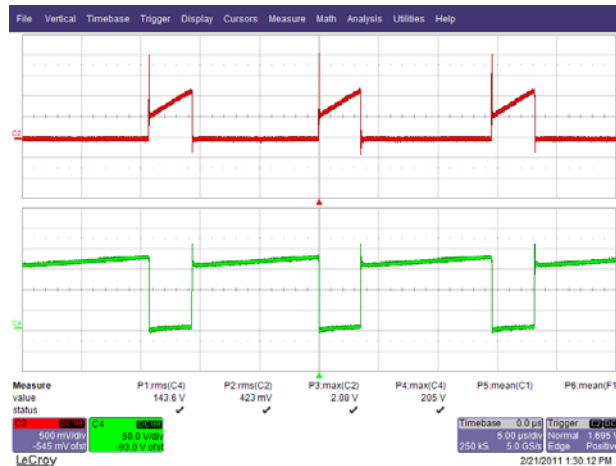


Figure 19 – 90 VAC 60Hz, Full Load.
Upper: I_{DRAIN} , 500 mA / div.
Lower: V_{DRAIN} , 50 V, 5 μ s / div.

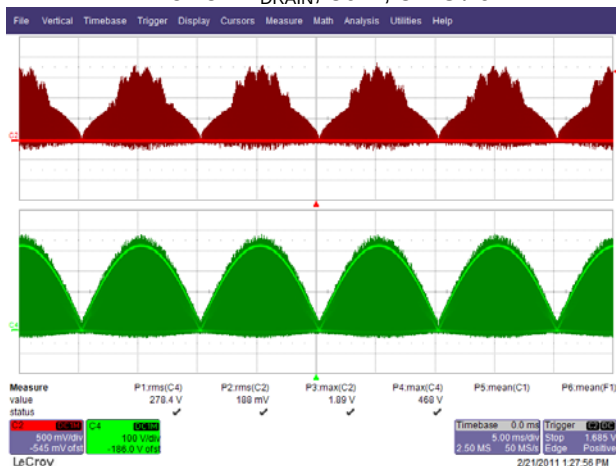


Figure 20 – 265 VAC 50 Hz, Full Load.
Upper: I_{DRAIN} , 500 mA / div.
Lower: V_{DRAIN} , 100 V, 5 ms / div.

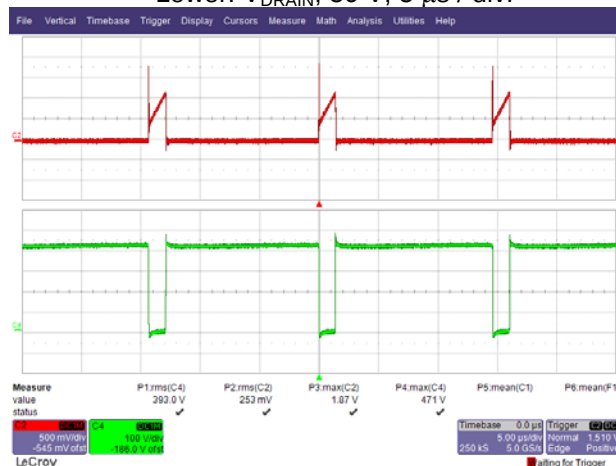


Figure 21 – 265 VAC 50 Hz, Full Load.
Upper: I_{DRAIN} , 500 mA / div.
Lower: V_{DRAIN} , 100 V, 5 μ s / div.

10.3 Drain Voltage and Current Start-up Operation

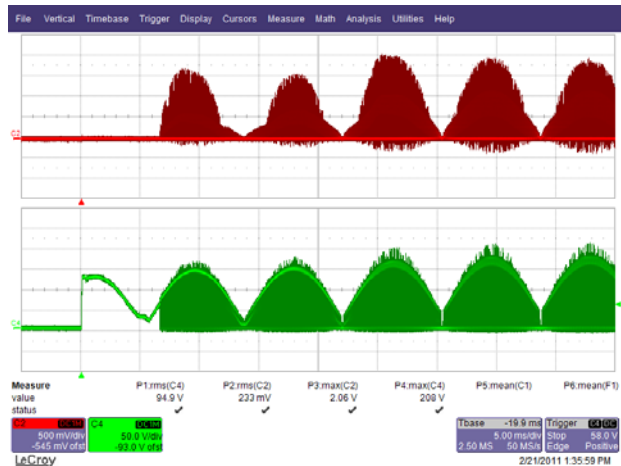


Figure 22 – 90 VAC 60 Hz, Full Load Start-up.

Upper: I_{DRAIN} , 500 mA / div.

Lower: V_{DRAIN} , 50 V, 5 ms / div.

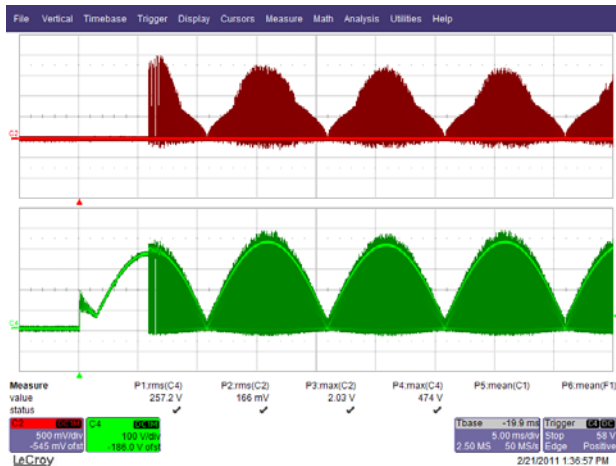


Figure 23 – 265 VAC 50 Hz, 90° Full Load Start-up.

Upper: I_{DRAIN} , 500 mA / div.

Lower: V_{DRAIN} , 100 V, 5 ms / div.

10.4 Output Current and Output Voltage

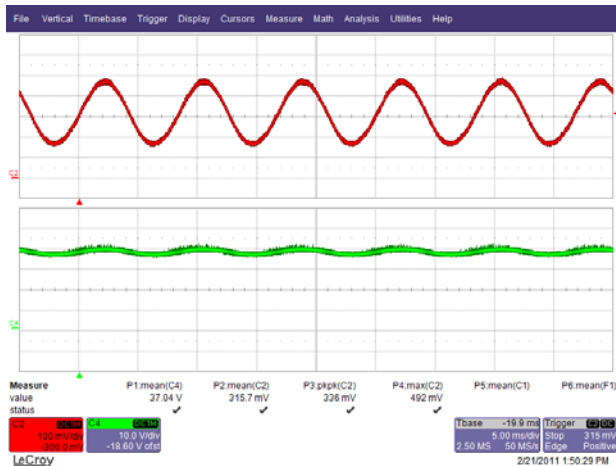


Figure 24 – 90 VAC 60 Hz, Full Load.
Upper: I_{OUT} , 100 mA / div.
Lower: V_{OUT} , 10 V, 5 ms / div.

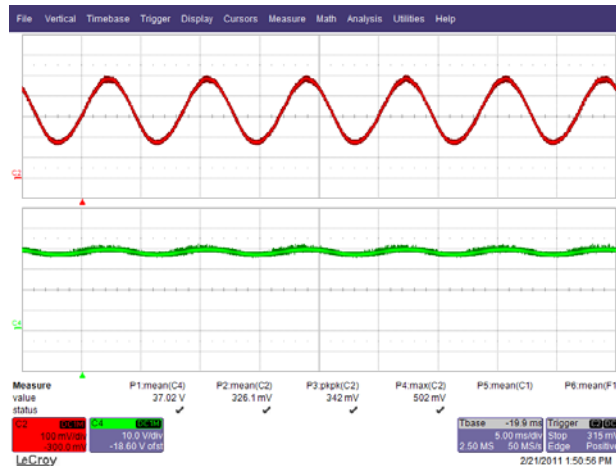


Figure 25 – 115 VAC 60 Hz, Full Load.
Upper: I_{OUT} , 100 mA / div.
Lower: V_{OUT} , 10 V, 5 ms / div.

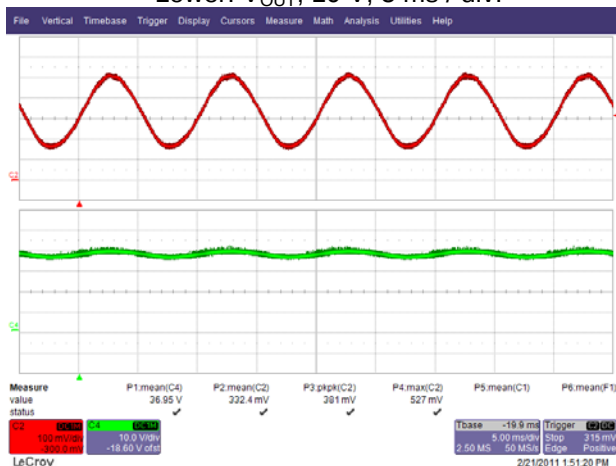


Figure 26 – 230 VAC 50 Hz, Full Load.
Upper: I_{OUT} , 100 mA / div.
Lower: V_{OUT} , 10 V, 5 ms / div.

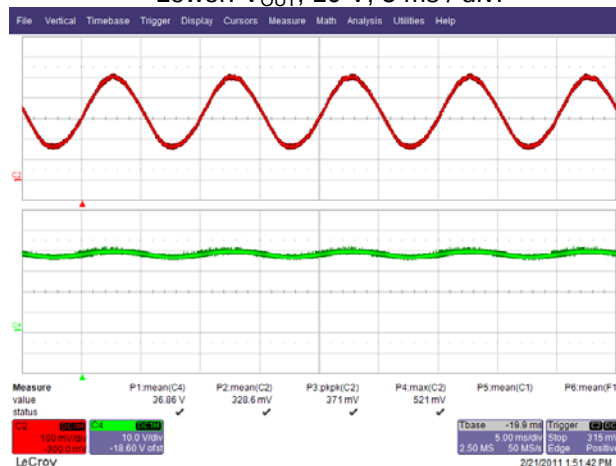


Figure 27 – 265 VAC 50 Hz, Full Load.
Upper: I_{OUT} , 100 mA / div.
Lower: V_{OUT} , 10 V, 5 ms / div.

10.5 Output Current and Voltage at Power-up, Power-down

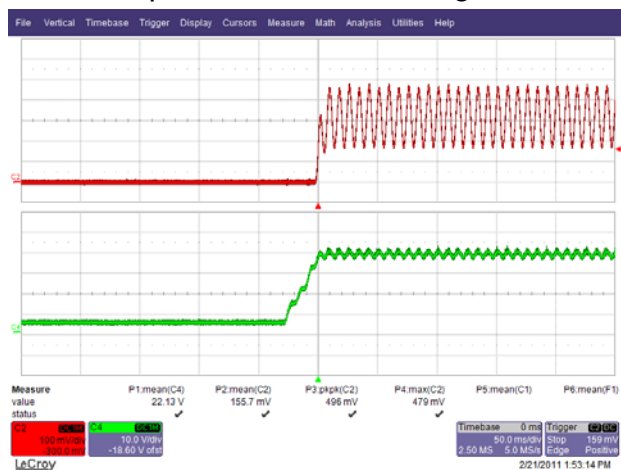


Figure 28 – 90 VAC 60 Hz, Output Rise.
Upper: I_{OUT} , 100 mA / div.
Lower: V_{OUT} , 10 V, 50 ms / div.

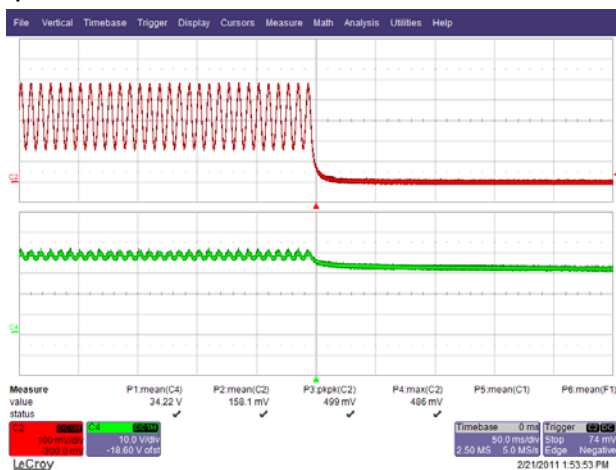


Figure 29 – 90 VAC 60 Hz, Output Fall.
Upper: I_{OUT} , 100 mA / div.
Lower: V_{OUT} , 10 V, 50 ms / div.

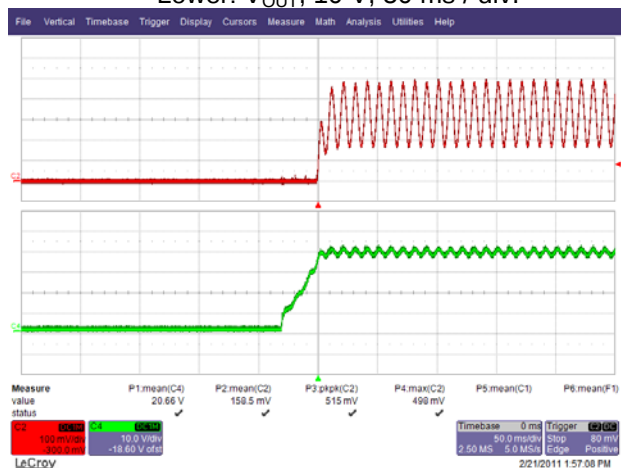


Figure 30 – 265 VAC 50 Hz, Output Rise.
Upper: I_{OUT} , 100 mA / div.
Lower: V_{OUT} , 10 V, 50 ms / div.

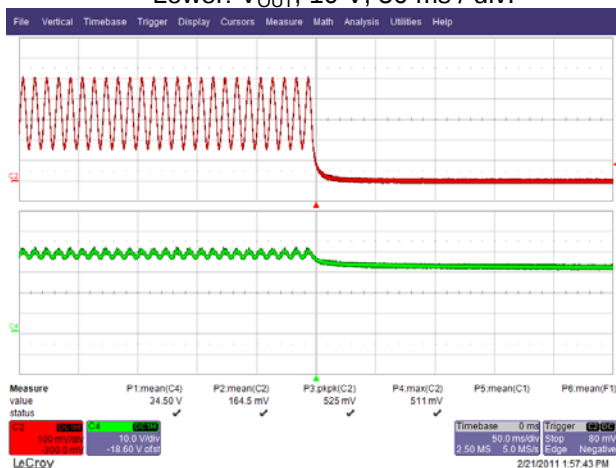


Figure 31 – 265 VAC 50 Hz, Output Fall.
Upper: I_{OUT} , 100 mA / div.
Lower: V_{OUT} , 10 V, 50 ms / div.

10.6 Output Short

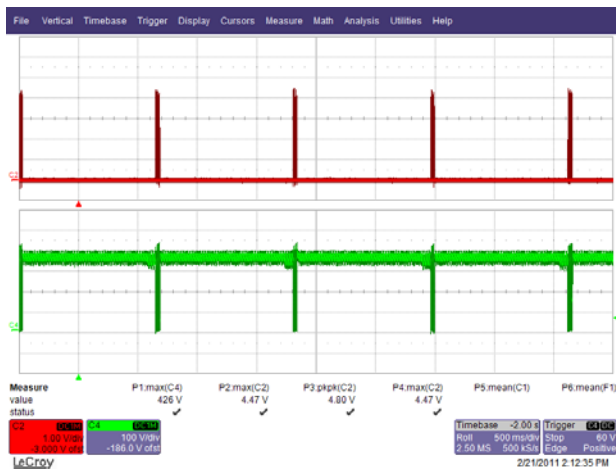


Figure 32 – 265 VAC 50 Hz, Output Short.

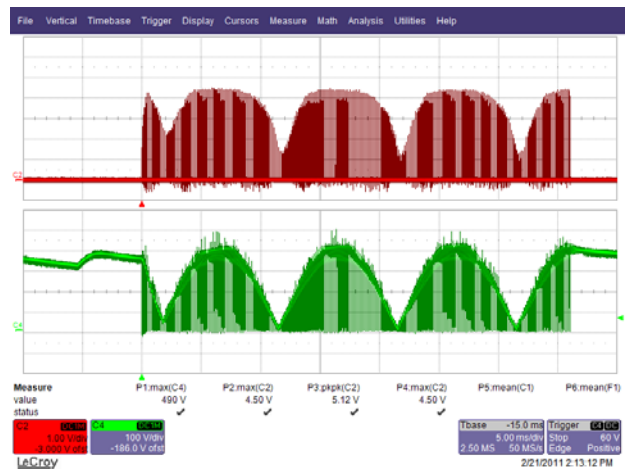
Upper: I_{DRAIN} , 1 A / div.Lower: V_{DRAIN} , 100 V, 500 ms / div.

Figure 33 – 265 VAC 50 Hz, Output Short.

Upper: I_{DRAIN} , 1 A / div.Lower: V_{DRAIN} , 100 V, 5 ms / div.

11 Thermal Measurements

Thermal measurements were done with the EUT operated at room temperature.



Figure 34 – 90 VAC 60 Hz, Thermals.
Top Side.
Device: U1 - LNK406EG

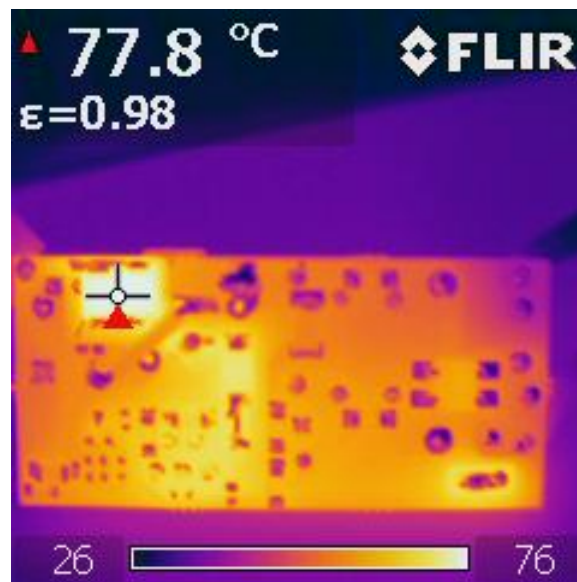


Figure 35 – 90 VAC 60 Hz, Thermals.
Bottom Side.
Device: D2, D3

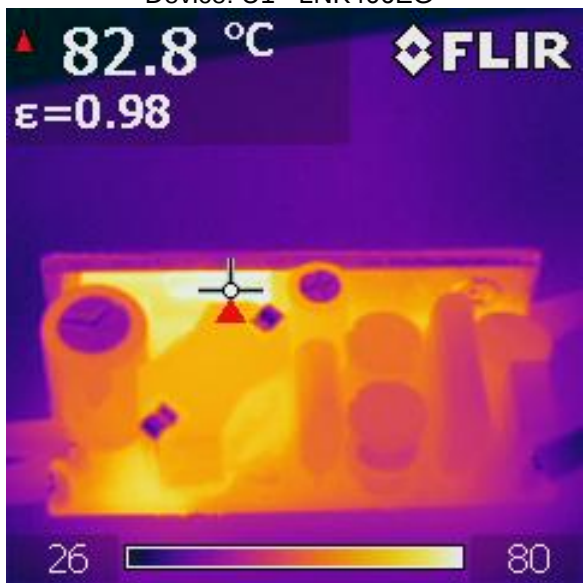


Figure 36 – 265 VAC 50 Hz, Thermals.
Top Side.
Device: U1 - LNK406EG

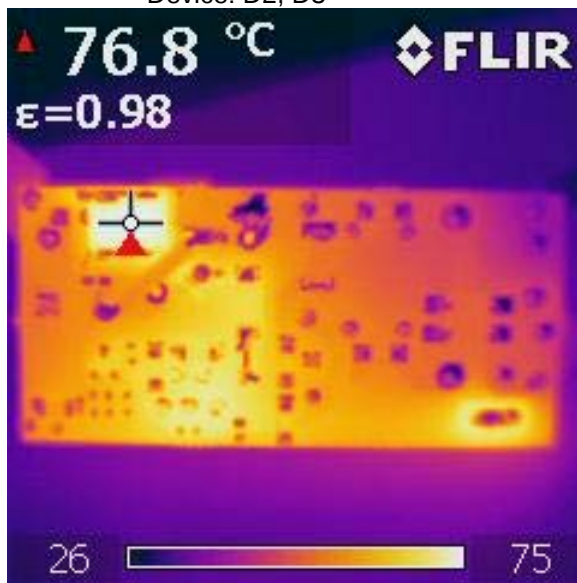


Figure 37 – 265 VAC 50 Hz, Thermals.
Bottom Side.
Device: D2, D3

11 Conducted EMI Measurements

11.1 Conducted EMI Test Set-up

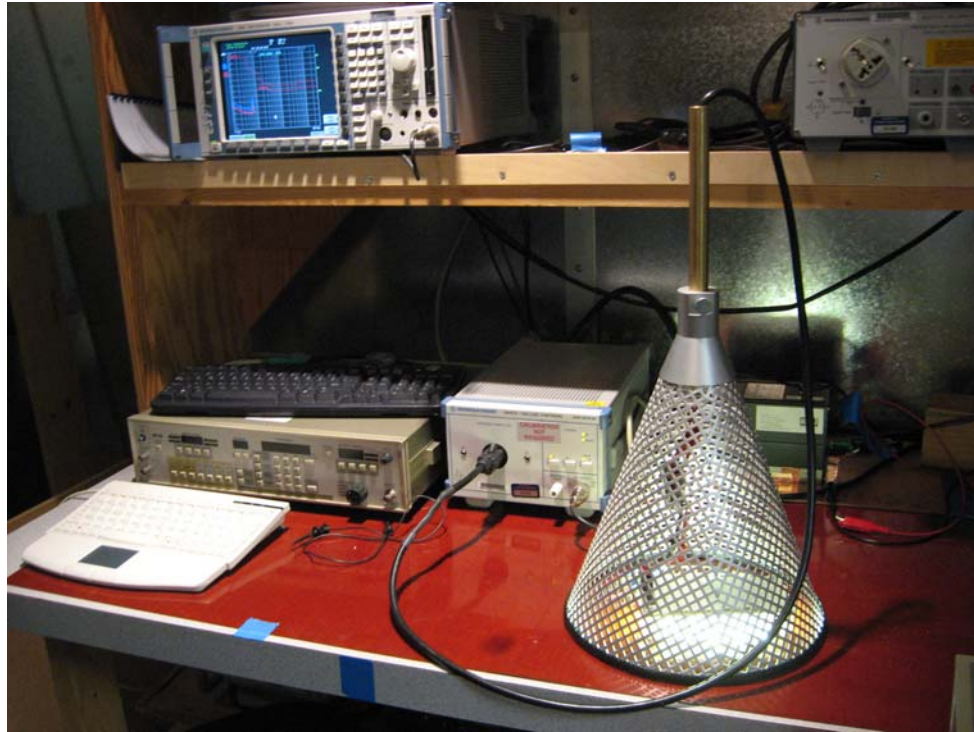


Figure 38 – EMI Measurement Set-up.

11.2 Conducted EMI Test Results

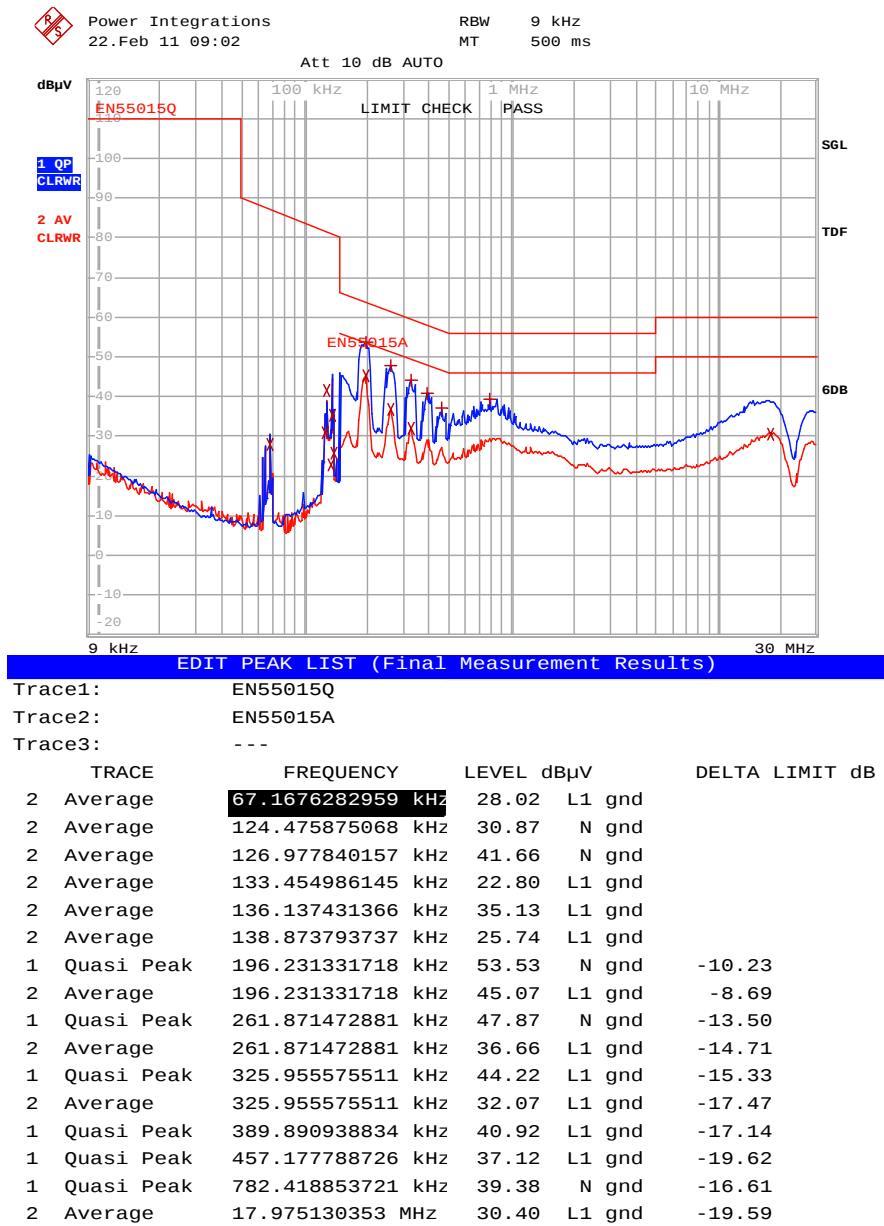


Figure 39 – Conducted EMI, 12 LED Load, 230 VAC, 60 Hz, and EN55015 Limits.





EDIT PEAK LIST (Final Measurement Results)

Trace1: EN55015Q

Trace2: EN55015A

Trace3: ---

TRACE	FREQUENCY	LEVEL dBμV	DELTA	LIMIT dB
2 Average	64.5467705779 kHz	33.38	L1 gnd	
2 Average	67.1676282959 kHz	34.73	N gnd	
2 Average	124.475875068 kHz	41.51	N gnd	
2 Average	126.977840157 kHz	41.55	L1 gnd	
2 Average	129.530094744 kHz	36.65	N gnd	
2 Average	136.137431366 kHz	47.61	L1 gnd	
2 Average	138.873793737 kHz	40.17	L1 gnd	
2 Average	162.428505844 kHz	33.89	L1 gnd	-21.44
1 Quasi Peak	196.231331718 kHz	55.07	N gnd	-8.69
2 Average	196.231331718 kHz	46.05	L1 gnd	-7.71
1 Quasi Peak	261.871472881 kHz	44.02	L1 gnd	-17.34
2 Average	261.871472881 kHz	34.52	L1 gnd	-16.84
1 Quasi Peak	393.789848222 kHz	39.10	N gnd	-18.87
1 Quasi Peak	457.177788726 kHz	40.27	L1 gnd	-16.47
1 Quasi Peak	520.310969312 kHz	38.50	L1 gnd	-17.49
1 Quasi Peak	782.418853721 kHz	37.78	N gnd	-18.21

Figure 40 – Conducted EMI, 12 LED Load, 115 VAC, 60 Hz, and EN55015 Limits.



12 Revision History

Date	Author	Revision	Description & changes	Reviewed
31-Mar-11	CA	1.0	Initial release	ME



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